EFC6601R

N-Channel Power MOSFET 24V, 13A, 11.5mΩ, Dual EFCP

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Features

- 2.5V drive
- Common-drain type
- 2KV ESD HBM

Specifications

Absolute Maximum Ratings at Ta=25°C

Parameter	Symbol	Conditions	Ratings	Unit
Source-to-Source Voltage	VSSS		24	V
Gate-to-Source Voltage	V _{GSS}		±12	V
Source Current (DC)	IS		13	А
Source Current (Pulse)	ISP	PW≤10µs, duty cycle≤1%	60	А
Total Dissipation	PT	When mounted on ceramic substrate (5000mm ² ×0.8mm)	2.0	W
Channel Temperature	Tch		150	°C
Storage Temperature	Tstg		-55 to +150	°C

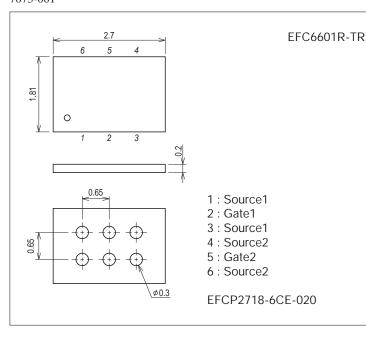
· Protection diode in

• Halogen free compliance

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

Package Dimensions

unit : mm (typ) 7073-001



Product & Package Information

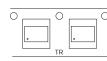
• Package	: EFCP
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• JEITA, JEDEC

• Minimum Packing Quantity : 5,000 pcs./reel

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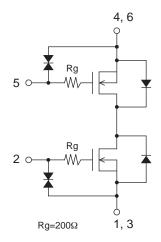
Taping Type : TR



MA

Marking

Electrical Connection

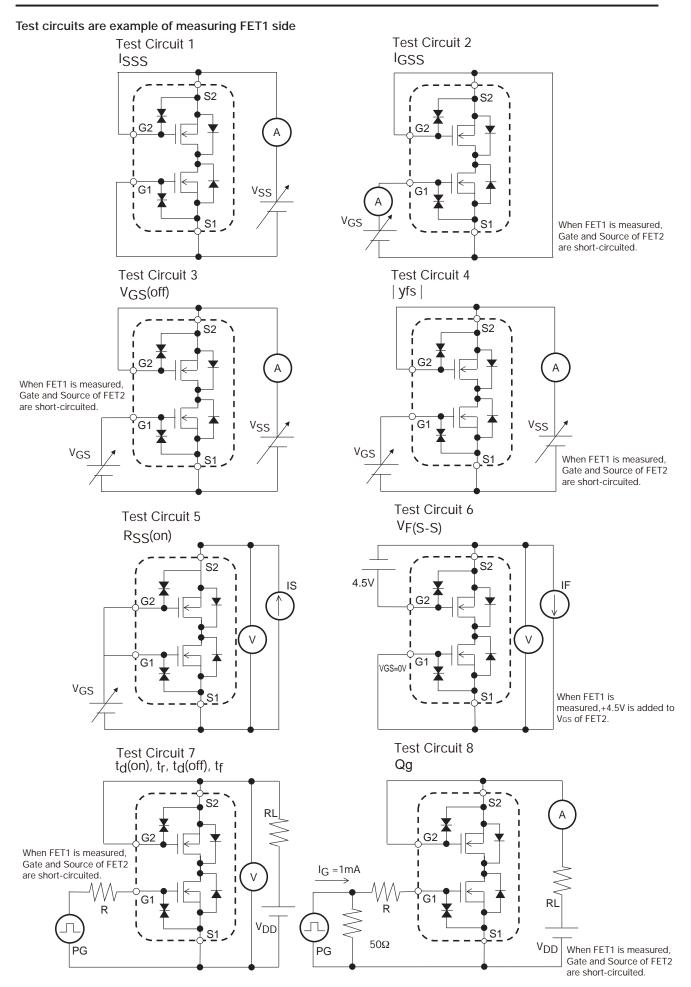


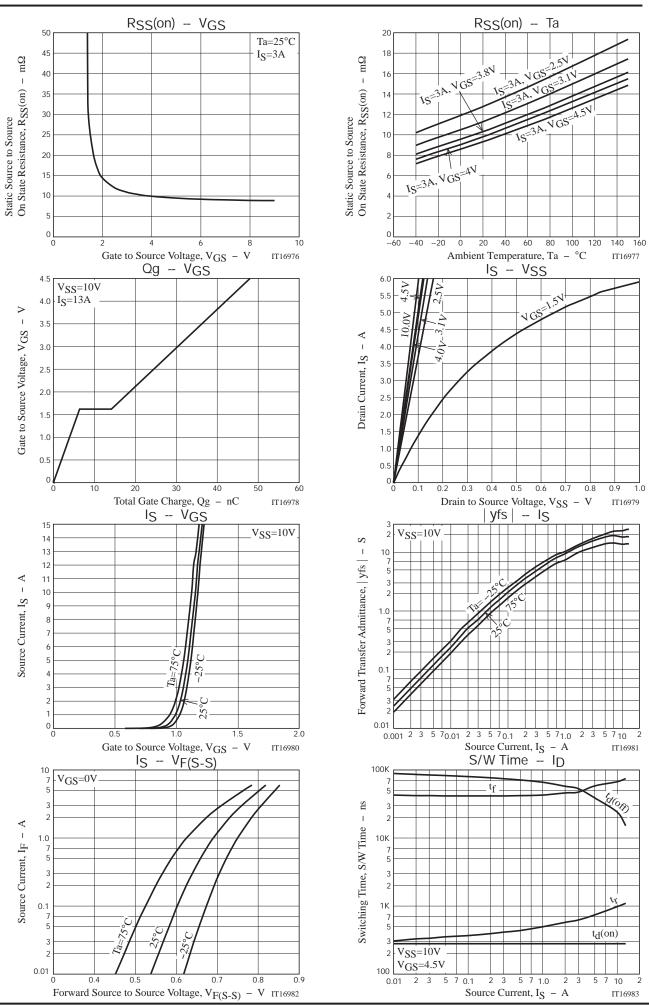
Electrical Characteristics at Ta=25°C

Deveryorker	Gurrahad	Conditions		Ratings			11
Parameter	Symbol			min	typ	max	Unit
Source-to-Source Breakdown Voltage	V(BR)SSS	IS=1mA, VGS=0V	Test Circuit 1	24			V
Zero-Gate Voltage Source Current	ISSS	VSS=20V, VGS=0V	Test Circuit 1			1	μΑ
Gate-to-Source Leakage Current	IGSS	VGS=±8V, VSS=0V	Test Circuit 2			±1	μΑ
Cutoff Voltage	VGS(off)	V _{SS} =10V, I _S =1mA	Test Circuit 3	0.5		1.3	V
Forward Transfer Admittance	yfs	VSS=10V, IS=3A	Test Circuit 4		15.5		S
Static Source-to-Source On-State Resistance	R _{SS} (on)1	IS=3A, VGS=4.5V	Test Circuit 5	6.6	9.5	11.5	mΩ
	R _{SS} (on)2	IS=3A, VGS=4.0V	Test Circuit 5	7.0	10	12	mΩ
	R _{SS} (on)3	IS=3A, VGS=3.8V	Test Circuit 5	7.3	10.5	13	mΩ
	RSS(on)4	IS=3A, VGS=3.1V	Test Circuit 5	8.0	11.5	15	mΩ
	RSS(on)5	IS=3A, VGS=2.5V	Test Circuit 5	9.0	13	17	mΩ
Turn-ON Delay Time	t _d (on)		Test Circuit 7		280		ns
Rise Time	tr				630		ns
Turn-OFF Delay Time	t _d (off)	V _{DD} =10V, V _{GS} =4.5V, I _S =3A			53000		ns
Fall Time	tf	1			47000		ns
Total Gate Charge	Qg	V _{DD} =10V, V _{GS} =4.5V, I _S =13A	Test Circuit 8		48		nC
Forward Source-to-Source Voltage	V _{F(S-S)}	IS=3A, VGS=0V	Test Circuit 6		0.76	1.2	V

Ordering Information

Device Package		Shipping	memo	
EFC6601R-TR	EFCP	5,000pcs./reel	Pb Free and Halogen Free	





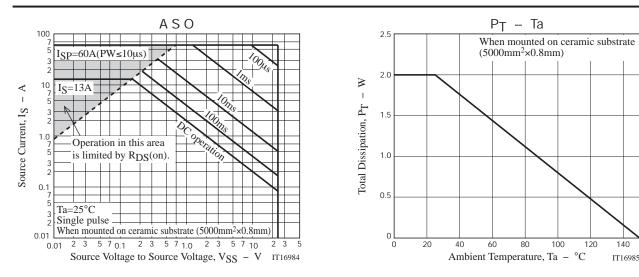
80

100

120

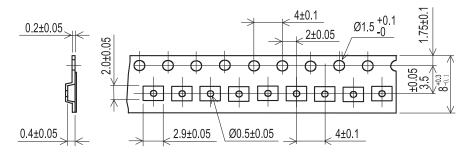
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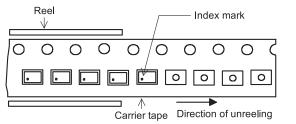


Taping Specification EFC6601R-TR

- 1. Taping Configuration
 - 1-1 .Carrier Tape Size (unit:mm)

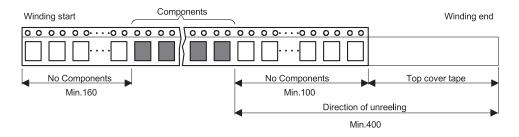


1-2 .Device Placement Direction

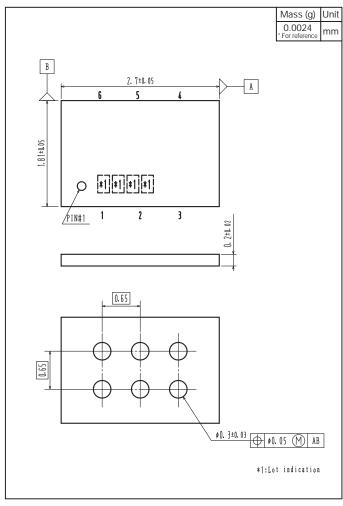


Packing type ····· TR

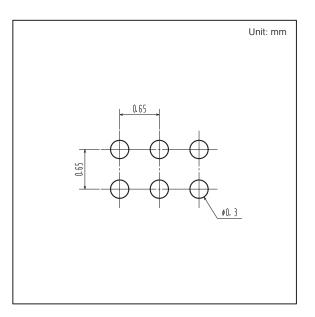
1-3 .Leader portion and Trailer portion (unit:mm)



Outline Drawing EFC6601R-TR



Land Pattern Example



Note on usage : Since the EFC6601R is a MOSFET product, please avoid using this device in the vicinity of highly charged objects.

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